



28 P14

2827

Attorney's Docket No.: 42390P9482 Patent  
In re the Application of: Kumamoto et al.  
(inventor(s))  
Application No.: 09/741,535  
Filed: December 19, 2000  
For: Molded Flip Chip Package  
(title)

ASSISTANT COMMISSIONER FOR PATENTS  
Washington, D.C. 20231

SIR: Transmitted herewith is an Amendment for the above application.

☐ Small entity status of this application under 37 C.F.R. §§ 1.9 and 1.27 has been established by a verified statement previously submitted.  
☐ A verified statement to establish small entity status under 37 C.F.R. §§ 1.9 and 1.27 is enclosed.  
☒ No additional fee is required.

The fee has been calculated as shown below:

(Col. 1)		(Col. 2)		(Col. 3)	SMALL ENTITY		OTHER THAN A SMALL ENTITY	
	Claims Remaining After Amd.		Highest No. Previously Paid For	Present Extra	Rate	Additional Fee	Rate	Additional Fee
Total Claims	4	Minus	30		X9	\$	X18	\$
Indep. Claims	2	Minus	3		X42	\$	X84	\$
<input type="checkbox"/> <b>First Presentation of Multiple Dependent Claim(s)</b>					+140	\$	+280	\$
					Total Add. Fee	\$	Total Add. Fee	\$0.00

\* If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3.

\*\* If the "Highest No. Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.

\*\*\* If the "Highest No. Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space. The "Highest No. Previously Paid For" (Total or Independent) is the highest number found from the equivalent box in Col. 1 of a prior amendment or the number of claims originally filed.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

on February 6, 2003  
Date of Deposit

Leah Schwenke

Name of Person Mailing Correspondence

Leah Schwenke

Signature

February 6, 2003

Date

\_\_\_\_\_ A check in the amount of \$\_\_\_\_\_ is attached for presentation of additional claim(s).  
\_\_\_\_\_ Applicant(s) hereby Petition(s) for an Extension of Time of \_\_\_\_\_ month(s) pursuant to  
\_\_\_\_\_ 37 C.F.R. § 1.136(a).

\_\_\_\_\_ A check for \$\_\_\_\_\_ is attached for processing fees under 37 C.F.R. § 1.17.  
\_\_\_\_\_ Please charge my Deposit Account No. 02-2666 the amount of \$\_\_\_\_\_.

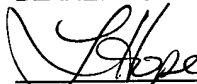
**A duplicate copy of this sheet is enclosed.**

  X   The Commissioner of Patents and Trademarks is hereby authorized to charge payment of the  
following fees associated with this communication or credit any overpayment to Deposit Account  
No. 02-2666 **(a duplicate copy of this sheet is enclosed):**

  X   Any additional filing fees required under 37 C.F.R. § 1.16 for presentation of  
extra claims.

  X   Any extension or petition fees under 37 C.F.R. § 1.17.

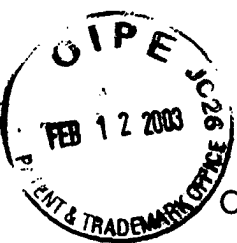
BLAKELY SOKOLOFF TAYLOR & ZAFMAN LLP

  
\_\_\_\_\_  
Libby Hope

Date: February 6, 2003

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(408) 720-8300

Reg. No. 46,774



Our Docket No.: 42390P9482

Patent

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Patent Application of:	)	
	)	
Kumamoto et al.	)	
	)	
Serial No.: 09/741,535	)	Examiner: Thai, Luan C.
	)	
Filed: December 19, 2000	)	
	)	Art Unit: 2827
For: MOLDED FLIP CHIP PACKAGE	)	
	)	

**SUPPLEMENTAL RESPONSE TO OFFICE ACTION**

Box Non-Fee Amendment  
Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

As a supplemental response to the Office Action mailed on September 25, 2002, and as suggested by Examiner's phone call of January 23, 2003, February 4, 2003, and February 6, 2003, the Applicants respectfully request the Examiner to enter the following amendment and to consider the following remark.

**FIRST CLASS CERTIFICATE OF MAILING**

I hereby certify that I am causing the above-referenced correspondence to be deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and that this paper or fee has been addressed to the Assistant Commissioner for Patents, Washington, D. C. 20231

February 6, 2003

Date of Deposit

Heah Schwenke

Name of Person Mailing Correspondence

Heah Schwenke  
Signature

2/6/03  
Date